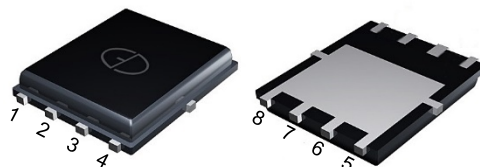


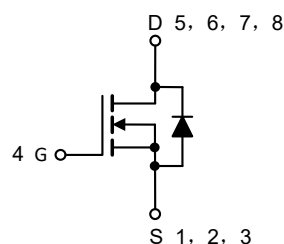
N-Channel 30V (D-S) Power MOSFET

Features

- 100% Avalanche Tested
- Extremely Low Losses with Low FOM $R_{DS(on)} \cdot Q_g$
- Halogen Free, Pb-Free
- RoHS Compliant



PDFN5060



Applications

- DC-DC
- Motors, lamps
- Power switching

Absolute Maximum Ratings ($T_J=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain Source Voltage	V_{DS}	30	V
Gate Source Voltage	V_{GS}	± 20	V
Drain Current, Continuous $V_{GS}=10\text{V}$	I_D	$T_C=25^\circ\text{C}$ 130	A
		$T_C=100^\circ\text{C}$ 82	
Drain Current, Pulsed (Note 1)	I_{DM}	521	A
Single Avalanche Energy (Note 2)	E_{AS}	160	mJ
Power Dissipation	P_D	$T_C=25^\circ\text{C}$ 63	W
		$T_C=100^\circ\text{C}$ 25	
Operating Junction/ Storage Temperature Range	T_J / T_{STG}	-55 to +150	$^\circ\text{C}$

Note 1: Single pulse; $t_p \leq 1\text{us}$.

Note 2: $V_{DD} = 15\text{V}$, $V_{GS} = 10\text{V}$, $L = 1\text{mH}$, $R_G = 25\Omega$, starting $T_J = 25^\circ\text{C}$.

Thermal Characteristics

Parameter	Symbol	Max	Unit
Thermal Resistance Junction to Case	R_{thJC}	2	$^\circ\text{C/W}$
Thermal Resistance Junction to Ambient (Note 3)	R_{thJA}	48	$^\circ\text{C/W}$

Note 3: Device mounted on 1 square inch FR4 PCB board, with 2oz single-sided copper, in a 25°C still air environment.

Electrical Characteristics (T_J = 25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =10mA	30	--	--	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =24V, V _{GS} =0V	--	--	0.5	mA
		V _{DS} =24V, V _{GS} =0V, T _J =125°C	--	0.2	--	
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _{DS} =250uA	1	1.5	2	V
Gate Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
Drain-Source On-state Resistance (Note 4)	R _{DS(on)}	V _{GS} =10V, I _D =20A	--	2	2.4	mΩ
		V _{GS} =4.5V, I _D =20A	--	2.7	3.5	
Total Gate Charge	Q _g	V _{GS(off)} =0V, V _{GS(on)} =10V, V _{DD} =15V, I _D =20A	--	21	--	nC
Gate-Source Charge	Q _{gs}		--	3.8	--	
Gate-Drain Charge	Q _{gd}		--	2.6	--	
Turn-on Delay Time	t _{d(on)}	V _{GS} =10V, V _{DD} =15V, I _D =20A, R _G =3Ω	--	3	--	ns
Turn-on Rise Time	t _r		--	11	--	
Turn-off Delay Time	t _{d(off)}		--	26	--	
Turn-off Fall Time	t _f		--	12	--	
Gate Resistance	R _g	V _{GS} =0V, f=1MHz, open drain	--	3.1	--	Ω
Input Capacitance	C _{iss}	V _{GS} =0V, V _{DS} =15V, f=1MHz	--	1437	--	pF
Output Capacitance	C _{oss}		--	1041	--	
Reverse Transfer Capacitance	C _{rss}		--	52	--	

Reverse Diode Characteristics (T_J = 25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Forward Current, Continuous	I _{SD}	T _C =25°C	--	--	60	A
Diode Forward Voltage (Note 4)	V _{SD}	I _F =2A, V _{GS} =0V	--	0.48	0.65	V
Reverse Recovery Time	T _{rr}	I _F = 20A, di/dt = 100 A/μs	--	31	--	ns
Reverse Recovery Charge	Q _{rr}		--	11.8	--	nC

Note 4: Pulse test; pulse width ≤ 380μs, duty cycle ≤ 1%.

Typical Characteristics Curves ($T_J = 25^\circ\text{C}$ unless otherwise noted)

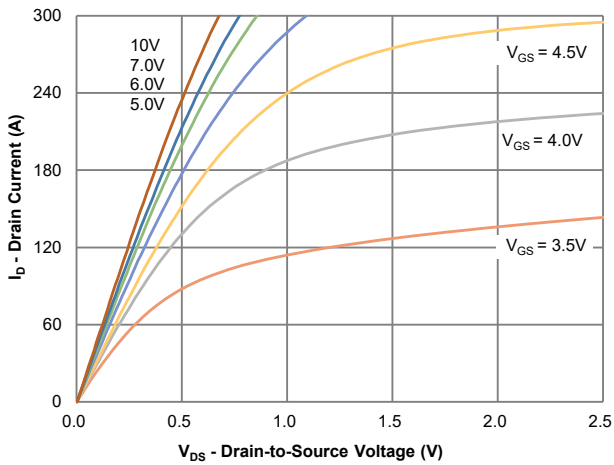


Figure 1: Output Characteristics

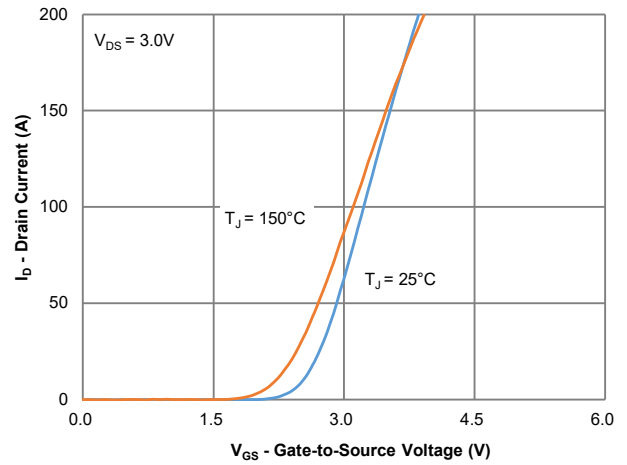


Figure 2: Transfer Characteristics

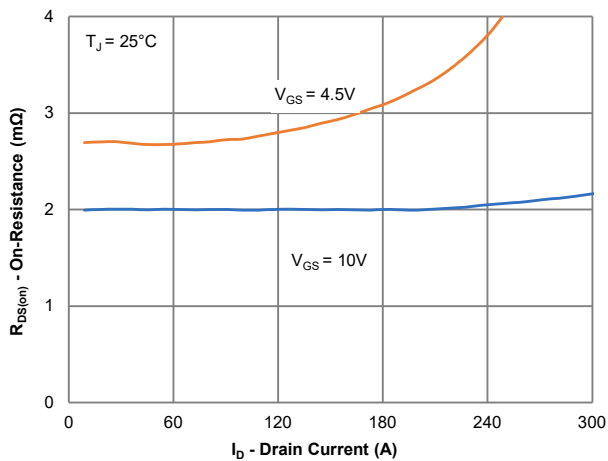


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

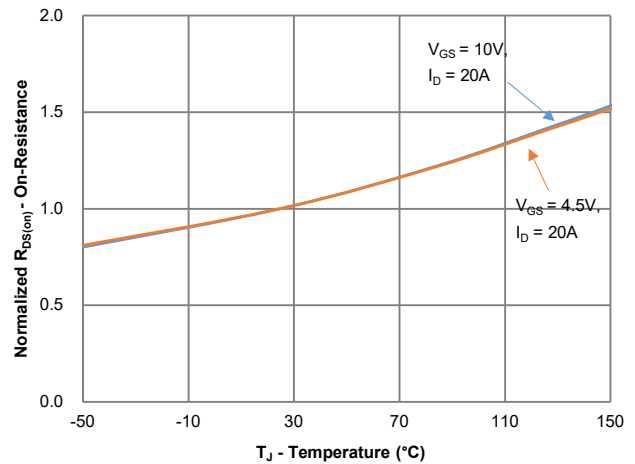


Figure 4: On-Resistance vs. Junction Temperature

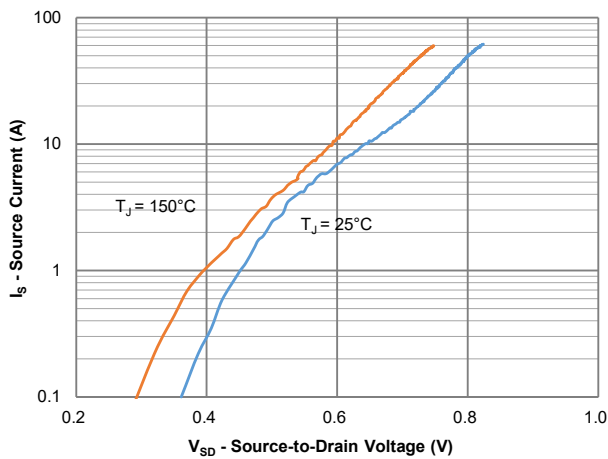


Figure 5: Source-Drain Diode Forward Voltage

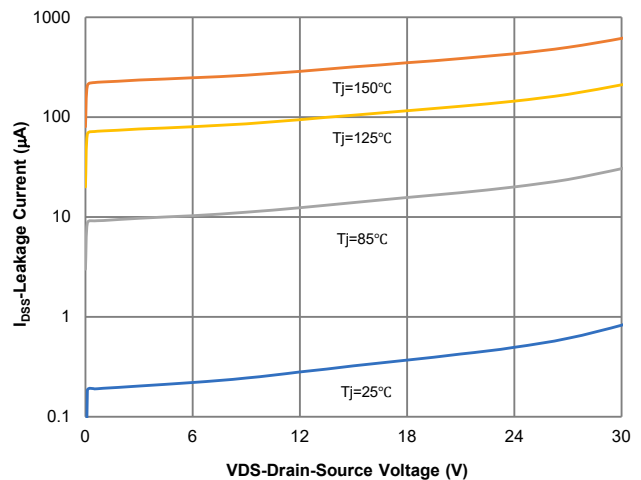


Figure 6: Typical Drain-Source Leakage Current vs Voltage

Typical Characteristics Curves ($T_J = 25^\circ\text{C}$ unless otherwise noted)

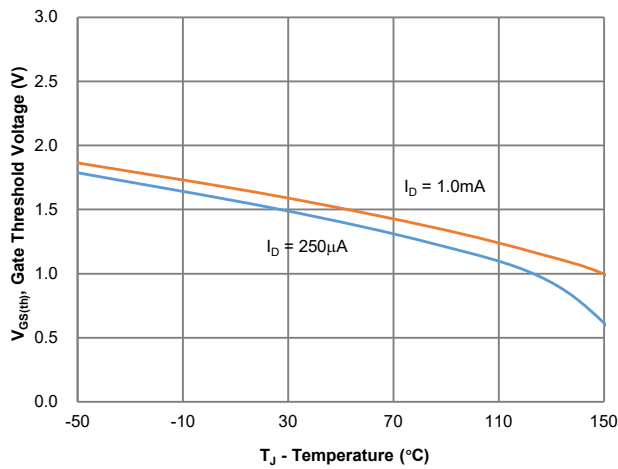


Figure 7: Gate Threshold Variation vs. Junction Temperature

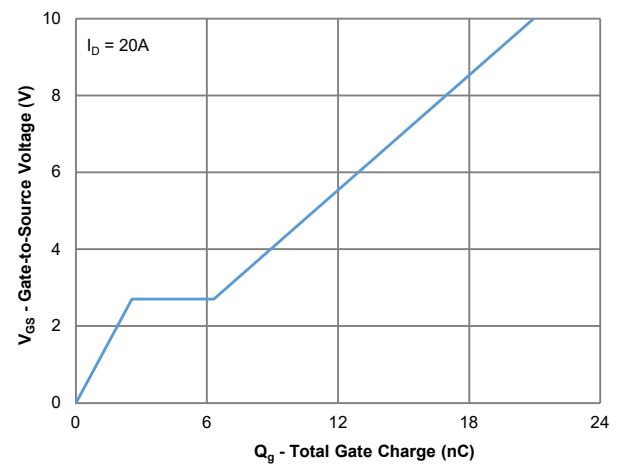


Figure 8: Gate Charge Characteristics

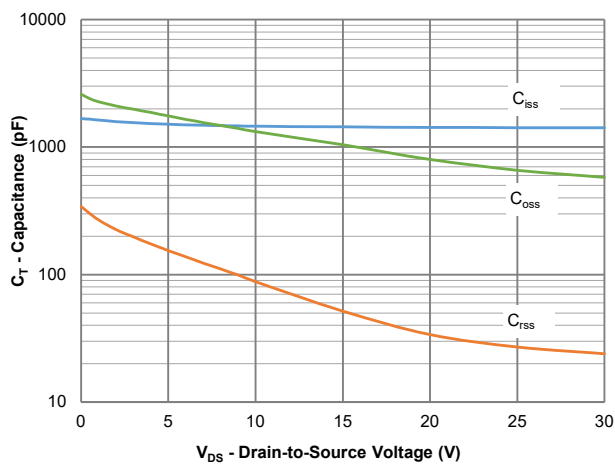


Figure 9: Capacitance Characteristics

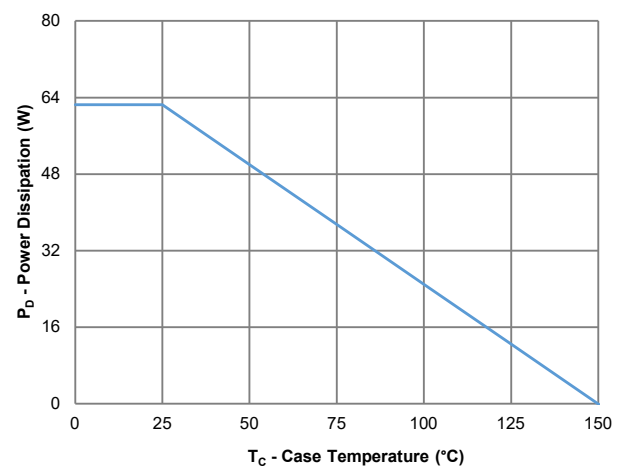


Figure 10: Power Derating

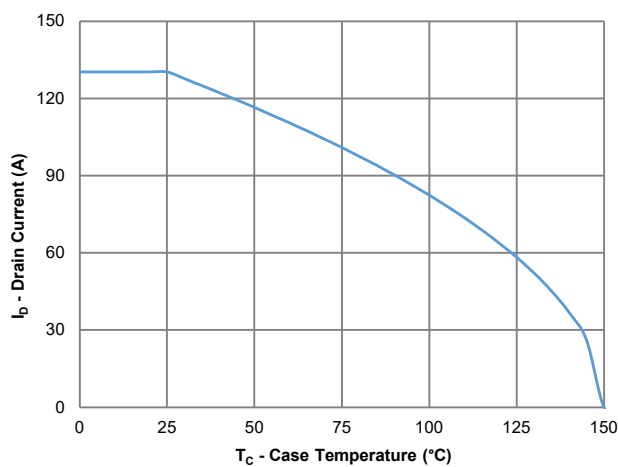


Figure 11: Current Derating

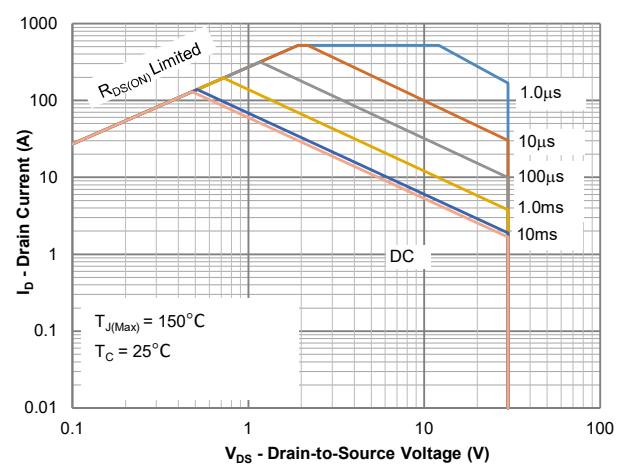


Figure 12: Safe Operating Area

Typical Characteristics Curves (T_J = 25°C unless otherwise noted)

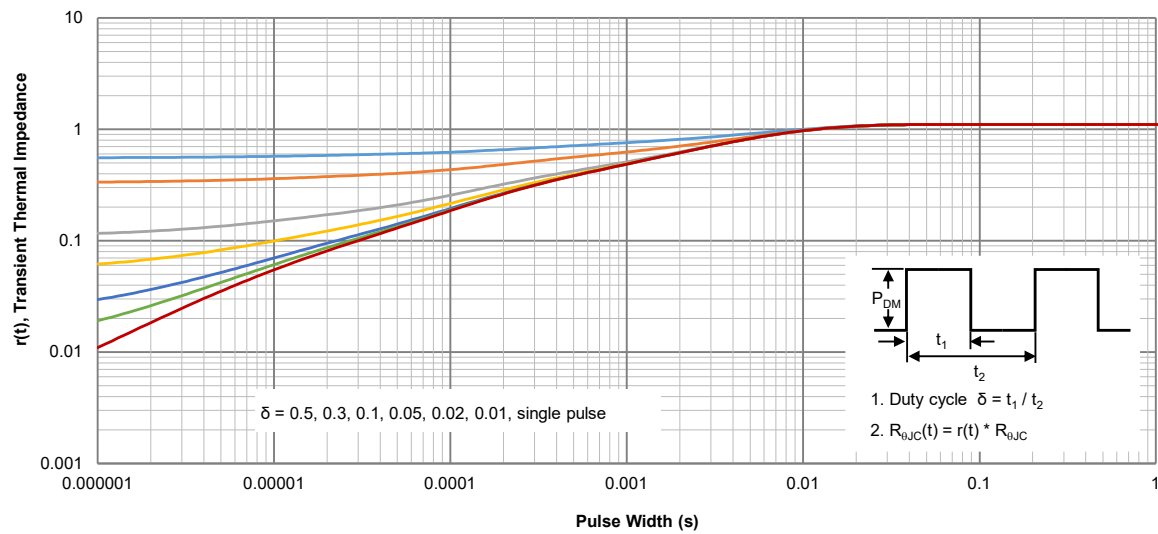
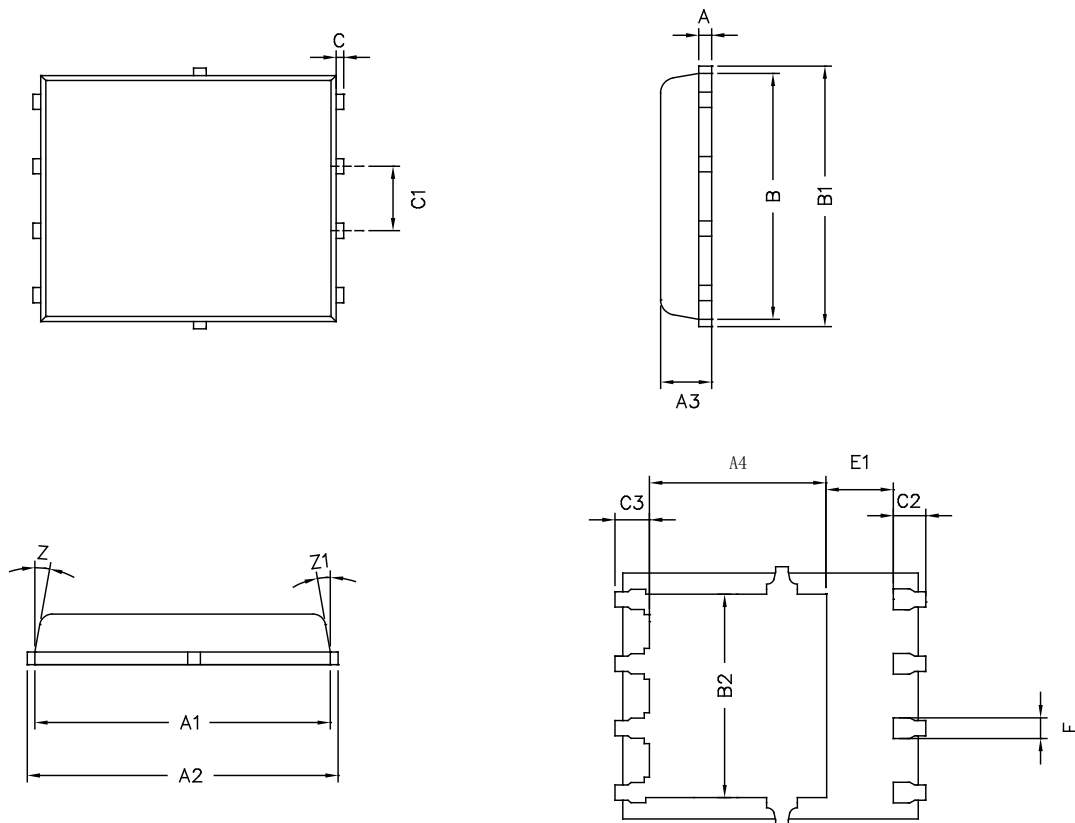


Figure 13: Normalized Maximum Transient Thermal Impedance

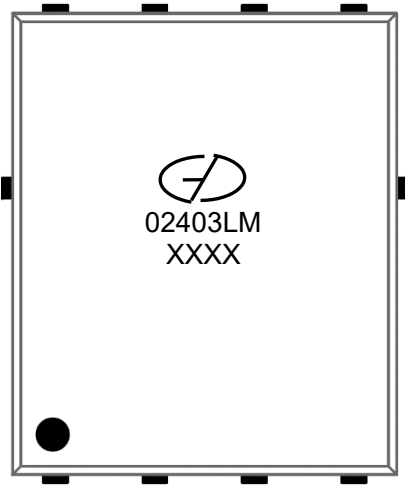
Package Outline Dimensions (Unit: millimeters)

PDFN5060



PDFN5060							
	Min.	Nom.	Max.		Min.	Nom.	Max.
A	0.15	0.25	0.35	C	0.05	0.15	0.25
A1	5.6	5.8	6.0	C1	1.17	1.27	1.37
A2	5.9	6.1	6.3	C2	0.53	0.63	0.73
A3	0.9	1.0	1.1	C3	0.53	0.63	0.73
A4	-	3.5	-	E	0.31	0.41	0.51
B	4.7	4.9	5.1	E1	1.2	1.3	1.4
B1	5.0	5.2	5.4	Z	8°	10°	12°
B2	-	4.01	-	Z1	8°	10°	12°

Marking Outline



Part Name: GMN02403LM

1. Logo Mark: 
2. P/N Mark: 02403LM
3. Date Code: XXXX
4. Pin 1#: ●

Revision History

Version	Date	Major Changes
Rev.A	2025.11.12	Official Release

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